GlobalWafers Co., Ltd.
環球晶圓股份有限公司

Global Family,
Global Solutions!

GlobalWafers (6488TT)
2025 Earnings Call

2026/03/11

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01

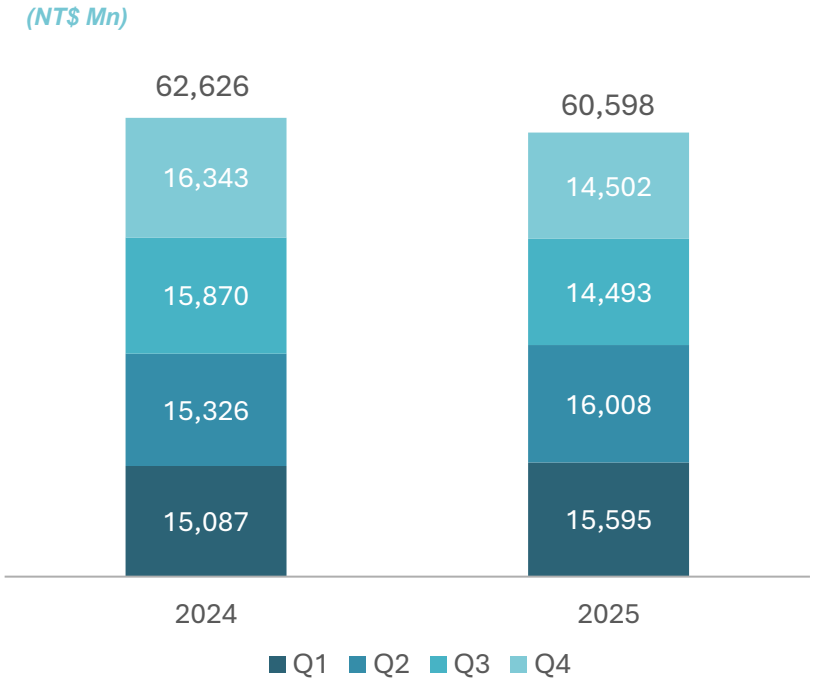
Executive Comment

Executive Comments

➢ Financial Highlights

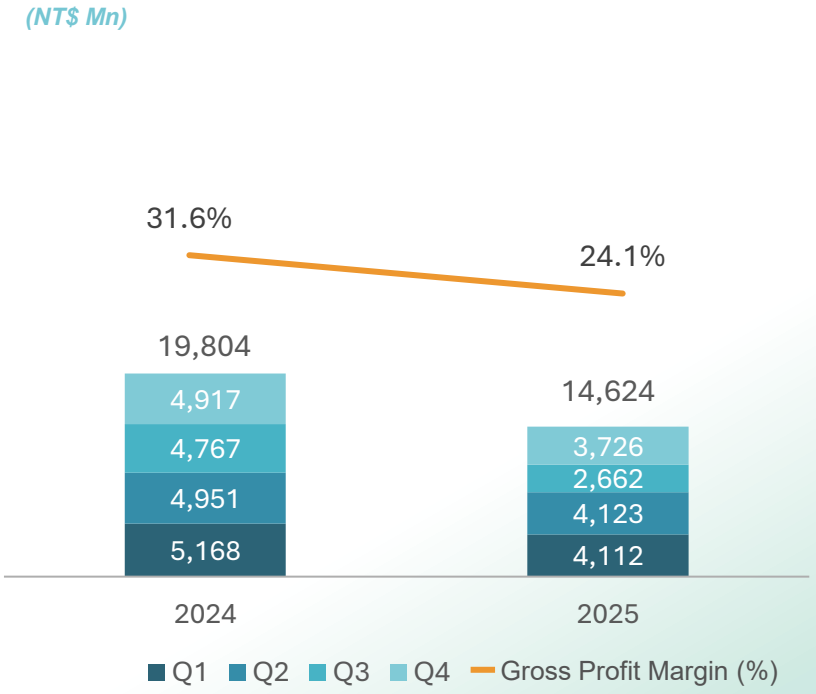
Revenue

- Q425 → NT$14.5 billion, 0.06% QoQ
- 2025 → NT$60.6 billion, -3.24% YoY



Gross Profit Margin (%)

- Q425 → 25.7%
- 2025 → 24.1%

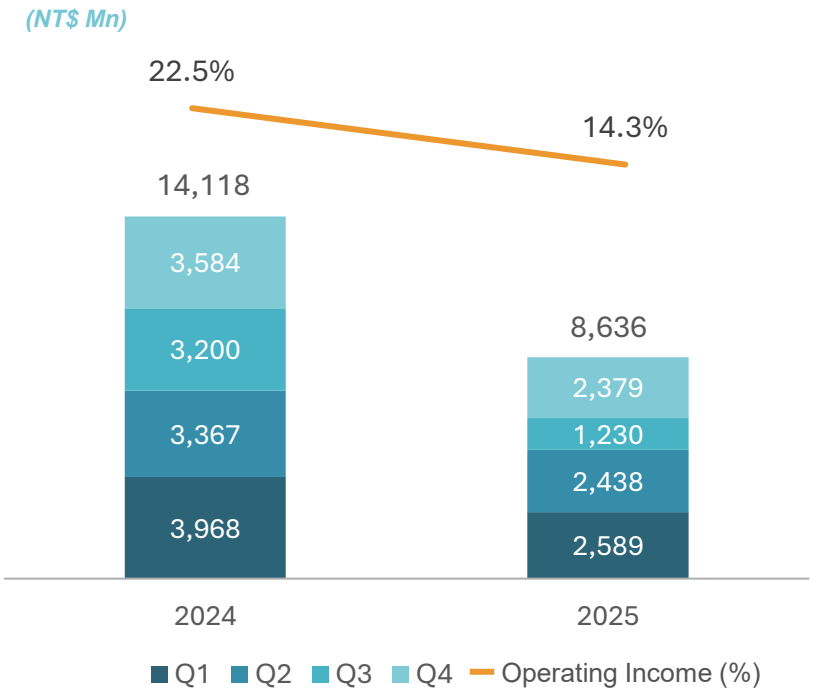


Executive Comments

➢ Financial Highlights

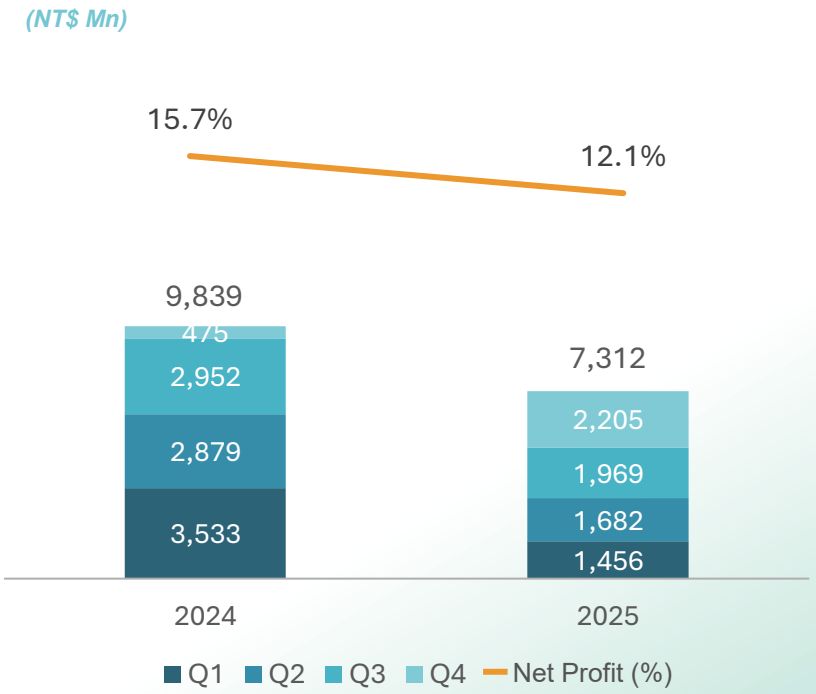
Operating Income (%)

- Q425 → 16.4%
- 2025 → 14.3%



Net Profit (%)

- Q425 → 15.2%
- 2025 → 12.1%

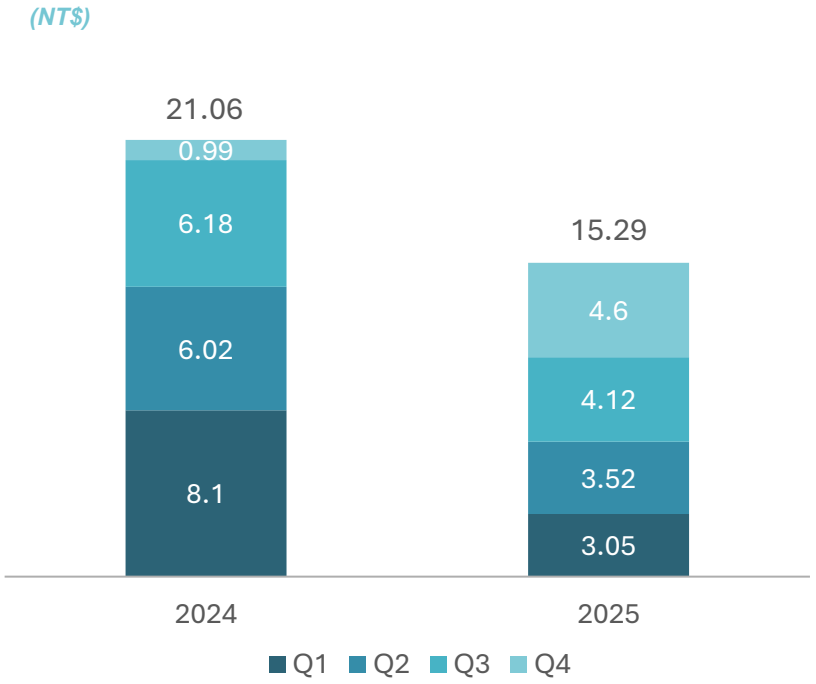


Executive Comments

➢ Financial Highlights

EPS

- Q425 → NT$4.60
- 2025 → NT$15.29



Prepayment

- NT$24.9 billion (US$ 0.79 bn)[1]

Planned Dividend Payout

- 2025 Dividend – NT$7.7 per share
  (1H25: NT$2.0 + 2H25: NT$5.7)
- 2025 Dividend Payout Ratio – 50.4%
- Record Date – July 22, 2026
- Payment Date – August 14, 2026

Note:
1. *FX Rate: NTD:USD = 31.4, including guarantee*
2. *Differences between quarterly and full-year EPS mainly result from variations in weighted average shares outstanding across quarters. Full-year EPS is therefore not a simple sum of quarterly figures.*

Executive Comments

➢ Industry & Overview

■ Global Growth Supported by AI Amid Policy and Trade Risks

- ✓ **AI and Trade Drive Outlook:** While strategic focus remains on AI durability and trade complexities, the emergence of humanoid robotics presents a pivotal synergy by linking sensor and power technologies to a boost in wafer volumes and precision machinery, requiring continued flexibility in supply chain and regional investment strategies to navigate trade tensions and secure the hardware essential for AI productivity scaling.
- ✓ **Trade Policy & Operational Resilience:** Although the previously announced reciprocal tariffs targeting Taiwan have been ruled invalid, tariffs continue to be treated as a prevailing market condition. While the details of the Section 232 measures have not yet been released, GlobalWafers plans for and executes its business with this reality in mind. U.S. policy continues to emphasize semiconductor supply chain resilience and domestic investment support. Leveraging its global localization strategy and robust compliance framework, GlobalWafers maintains the operational flexibility necessary to mitigate risks arising from regulatory and policy developments.

Executive Comments

➢ Industry & Overview

■ AI Reshapes Semiconductor Growth and Pricing Power

- ✓ **Value-Led Growth Supported by AI:** Semiconductor growth is increasingly driven by higher-value AI products, shifting revenue mix toward price and value rather than volume, reducing reliance on traditional volume cycles.
- ✓ **Uneven Recovery Across Nodes:** AI demand anchors growth as cloud and AI customers prioritize performance and deployment speed, supporting demand for advanced nodes, while mature nodes recover gradually on supply discipline and steady power and specialty demand.
- ✓ **Moderate ASP Improvement Supported by AI and Localization:** The semiconductor wafer market is expected to improve modestly in 2026 relative to 2025. AI-related demand supports higher utilization in 12-inch advanced wafers, SOI, and GaN, contributing to gradual ASP improvement through product mix optimization and tight supply.
- ✓ **GlobalWafers Positioned to Capture Both AI and Broad-Based Demand:** Building on these trends, GlobalWafers' expansion across six countries aligns with advanced-node and AI-driven demand, while improving momentum in 6-inch, 8-inch, and compound semiconductors, including urgent customer orders, supports a more balanced recovery across product segments.

End-Market Trends Indicate Structural Support Beyond Cyclical Recovery

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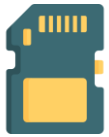
Compute & AI Infrastructure

Structurally Resilient

- AI infrastructure investment remains structurally resilient, supported by hyperscale data center expansion and the shift toward custom silicon (ASICs). Leading players are front-loading advanced-node capacity to secure future inference demand, reducing sensitivity to traditional semiconductor cycles.



Memory Market

Solid Fundamentals

- The memory sector is entering a structural upcycle shaped by a tight supply dynamic. Capacity is being reallocated toward HBM and AI-driven workloads, constraining legacy supply and strengthening supplier pricing leverage. This shift is prompting OEMs to adjust BOM structures and accommodate a higher-value memory mix across HBM, DDR5, and enterprise SSD.

Smartphone & PC

Value-Driven Demand

- Consumer markets are becoming more value-driven as rising BOM costs push OEMs toward premium, AI-enabled devices. This supports ASP resilience, while unit growth remains moderate as consumers extend replacement cycles.

Source: GWC Intelligence; Omdia (Dec 2025); IDC (Dec 2025)

End-Market Trends Indicate Structural Support Beyond Cyclical Recovery (cont'd)

Automotive & Industrial

Gradual Recovery

- The market has gradually normalized from its inventory peak; however, inventories remain in a soft recovery phase, and supply remains relatively loose. Automotive demand is stable but subdued, with uneven regional trends and cautious EV adoption; hybrids and SDV investments support automotive electronics, though growth remains gradual rather than cyclical. In Europe, recovery is driven more by pricing and product mix than by volume, pointing to a slow, back-half-weighted normalization in 2026.

Advanced Packaging

Primary Engine For Value Creation

- Semiconductor packaging has shifted from a protective enclosure to a primary engine for value creation. While advanced packaging represents a small fraction of total wafer volume, it is the critical enabler for breakthroughs in AI, HPC, and Silicon Photonics. As system complexity and performance requirements continue to rise, demand for advanced and specialty wafers is increasing across advanced technology platforms. Ultimately, these applications enhance long-term visibility and support stable utilization of advanced production capacity.

Source: GWC Intelligence; Omdia (Dec 2025); IDC (Dec 2025)

Executive Comments

➢ Industry & Overview

■ GlobalWafers Well Positioned for Long-Term Structural Growth

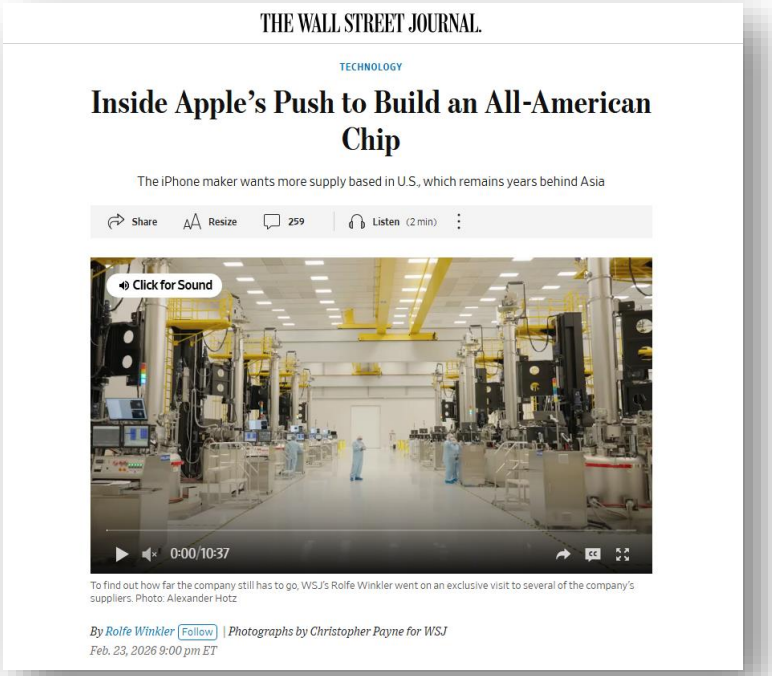
- ✓ **Global Expansion Turning to Contribution**: Localized manufacturing across Asia, the U.S., and Europe mitigates geopolitical and supply chain risks. Brownfield expansions in Asia and Denmark delivered solid revenue, while new fabs in Italy and the U.S. accelerated qualifications and pilot shipments. As utilization improves and subsidies phase in, the focus has shifted from construction to volume ramp, with expansion benefits beginning to contribute to revenue.

- ✓ **AI Demand Supporting Utilization**: AI, silicon photonics, and HPC demand are strengthening visibility across advanced and specialty wafers, with ongoing efforts in yield improvement and production ramp-up helping to sustain utilization of key lines. Inventory normalization in mature nodes is also contributing to more stable orders and shipments, with demand trends gradually recovering.

- ✓ **Specialty Mix Enhancing Profitability**: SOI visibility remains solid in Missouri. GaN capacity is fully utilized, with the new 30% expansion fully booked. SiC is advancing from 6/8-inch to next-generation 12-inch and semi-insulating products now entering customer qualification, further increasing the mix of high-value specialty products.

Global Media Spotlight on GlobalWafers' Texas Fab Highlighting the Strategic Value of U.S. Localization

- A recent report by The Wall Street Journal noted that as technology company Apple continues to promote the development of a more complete semiconductor supply chain in the United States, GlobalWafers' new wafer facility in Sherman, Texas, has been identified as one of the important upstream supply bases.
- GlobalWafers' new plant in Texas (GWA) is primarily responsible for transforming high-purity silicon into wafers used in subsequent chip manufacturing, serving as an essential source of foundational materials for the semiconductor industry. As global supply chains undergo restructuring and localization trends accelerate, the company's investments and presence in the United States are gradually demonstrating their strategic value. GlobalWafers continues to strengthen its role within the global semiconductor supply chain, providing international customers with stable and resilient support in critical materials.



THE WALL STREET JOURNAL.

TECHNOLOGY

Inside Apple's Push to Build an All-American Chip

The iPhone maker wants more supply based in U.S., which remains years behind Asia

Share Resize 259 Listen (2 min)

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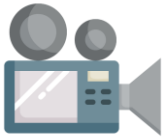
0:00/10:37

To find out how far the company still has to go, WSJ's Rolfe Winkler went on an exclusive visit to several of the company's suppliers. Photo: Alexander Hotz

By Rolfe Winkler Follow | Photographs by Christopher Payne for WSJ

Feb. 23, 2026 9:00 pm ET

For the full article, please refer to *The Wall Street Journal*
Inside Apple's Push to Build an All-American Chip – WSJ



Watch the full video:
https://www.youtube.com/watch?v=ktFlaBhpMu8

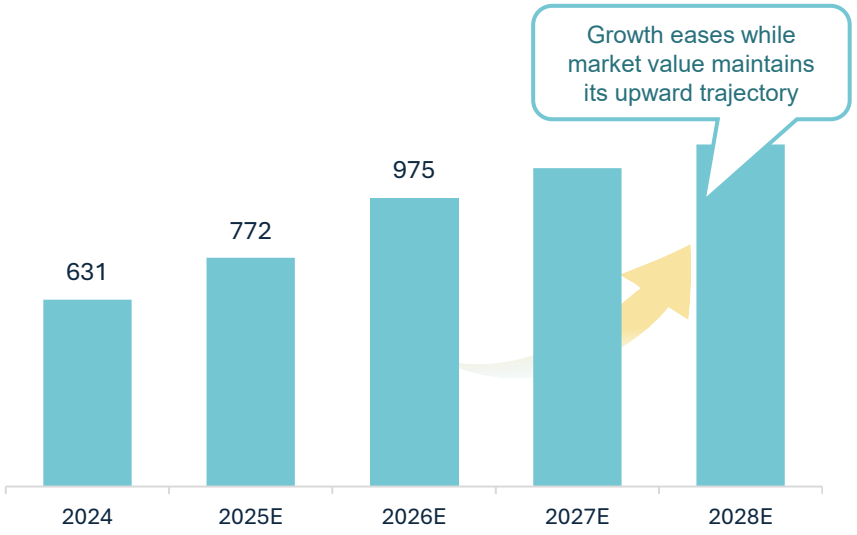
02

Company Overview

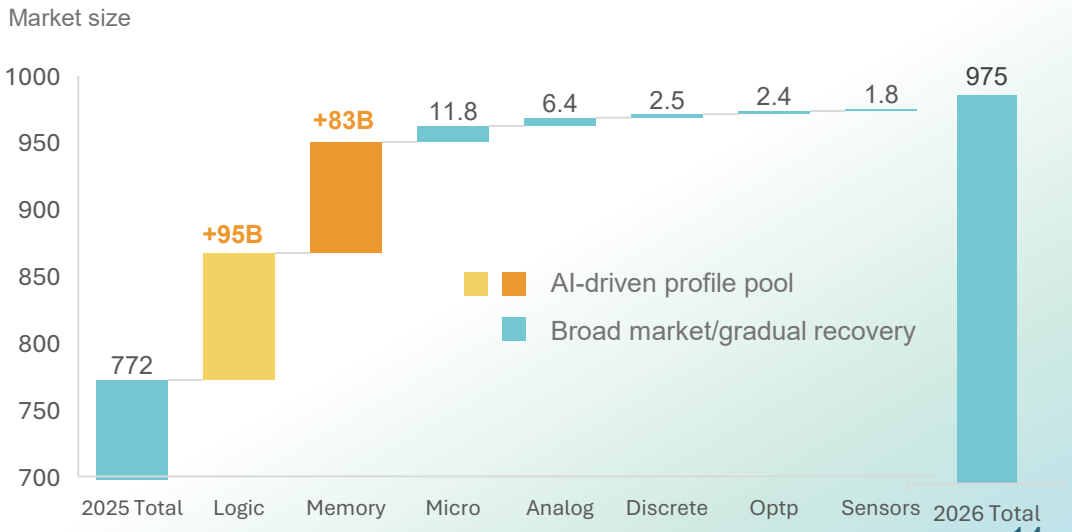
Structural Shift Toward Value-Driven Semiconductor Growth

- **Market Shift Toward Price-Driven Growth:** The global semiconductor market is projected to grow ~25% YoY to $975B in 2026. Industry growth is becoming more value-oriented rather than volume-led, as higher-ASP products such as GPUs, ASICs and HBM represent an increasing share of revenue. This trend indicates a decoupling from traditional shipment-driven cycles.
- **Advanced Nodes as the Primary Growth Driver:** Approximately 88% of incremental growth driven by AI-related Logic and Memory. Cloud and AI customers continue to prioritize performance and timely deployment, supporting stable revenue visibility for advanced-node and high-end memory suppliers.
- **Mature Nodes Moving Toward Normalization:** Utilization is expected to remain above 80% in 2026, supported by AI data center demand for SiPho, SiGe, and high-efficiency PMICs. Ongoing 8-inch capacity reductions are gradually tightening supply–demand conditions, while selective price adjustments by leading foundries suggest improving pricing discipline and a possible recovery in profitability.

Global Semiconductor Market (US$ Bn)



Global Semiconductor Market by Products (US$ Bn)

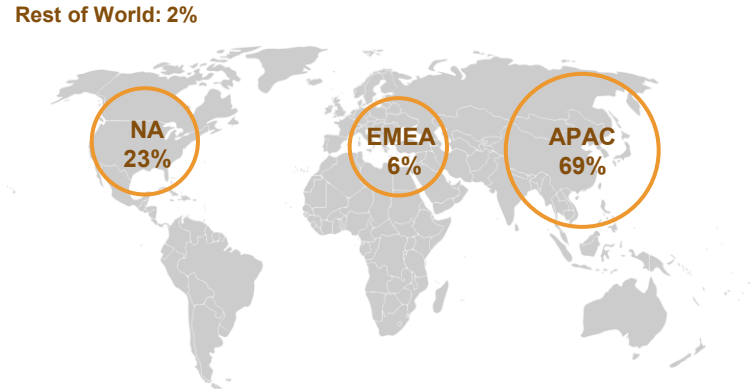


Source: WSTS (Dec 2025); IDC (Dec 2025)

GWC Leveraging Global Balance in a Regionalizing Market

- **Global Semiconductor Investment Is Gradually Regionalizing:** From 2024 to 2030, global semiconductor equipment spending is expected to reach approximately US$1.1 trillion. While advanced processes remain concentrated, semiconductor investment is extending beyond Asia toward North America and Europe, driven by U.S. policy support and rising supply-chain de-risking requirements.
- **GWC Benefits from a Balanced Global Footprint:** Against this backdrop, GWC maintains a well-balanced, multi-regional manufacturing footprint across Asia, the United States, and Europe. This diversified platform enables closer customer collaboration, supports localization requirements, and mitigates geopolitical and supply chain risks, translating regional investment trends into tangible, qualified capacity while strengthening long-term operational resilience.

Accumulated Semiconductor Equipment Spending



~$1.1 trillion

Global accumulated equipment spending, ’24-’30F

GlobalWafers’ Latest Global Expansion Progress

USA (Texas)
GWA ramping with customer qualifications underway;
~300kpcs/month capacity expected.

USA (Missouri)
12” SOI line under customer qualification for RF-SOI and silicon photonics.

Italy
12” fab in qualification and early shipment phase, supported by ~25% government subsidy.

Japan
GWJ capacity expansion;
MJL 12-inch EPI expansion supporting shipment growth.

Korea
Crystal growth capacity expanded with additional pullers.

Taiwan
12-inch EPI upgrade;
Expanding GaN, square wafers, and 12-inch SiC.

Source: PwC《Semiconductor and beyond 2026》, September 2025

High-Barrier Specialty Wafer Platforms Driving Long-Term Visibility

- **High-Barrier Specialty Platforms with Durable Profitability:** FZ and SOI address critical applications that demand ultra-high purity, tight specifications, and multi-year qualifications, leading to limited supplier competition, high customer stickiness, and structurally resilient demand.
- **Structural Exposure to Power, Connectivity and Emerging Quantum Technologies:** Beyond traditional semiconductor cycles, FZ and SOI are positioned in long-term secular growth areas including automotive power, RF connectivity, silicon photonics, sensing, and early-stage quantum technologies, providing diversified and non-cyclical demand drivers.
- **Enhancing Portfolio Stability and Long-Term Visibility:** Together with 12-inch and compound semiconductors, FZ and SOI further expand GWC's high-ASP specialty mix, supported by regional manufacturing and long-term customer engagements, strengthening earnings stability and supply-chain resilience.

FZ: High-Purity Moat with Quantum Upside

- Ultra-High Purity & Low-Defect Performance
- Limited Global Suppliers, High Technical Barriers
- Quantum-Grade Substrates with Growing Research Demand

SOI: Vertical Integration with U.S. Supply Advantage

- SOI Platform Enabling AI & Silicon Photonics
- U.S.-based 12" SOI Fab with Production Stability & Delivery Reliability
- Only fully integrated, IP-independent layer-transfer SOI platform

Specialty wafers positioned for ~10–15% CAGR growth

03

Financial Performance

Financial Highlight : Q425 vs. Q325 vs. Q424

(NT$Mn, except EPS)	Q425	Q325	Q424	QoQ	YoY
Revenue	14,502	14,493	16,343	0.1%	-11.3%
Gross Profit %	25.7%	18.4%	30.1%	7.3p.p.	-4.4p.p.
Operating Income	2,379	1,230	3,584	93.5%	-33.6%
Operating Income %	16.4%	8.5%	21.9%	7.9p.p.	-5.5p.p.
Net Profit	2,205	1,969	475	12.0%	364.3%
Net Profit %	15.2%	13.6%	2.9%	1.6p.p.	12.3p.p.
EPS[1]	NT$4.60	NT$4.12	NT$0.99	NT$0.48	NT$3.61
EBITDA[2]	4,460	4,376	2,504	1.9%	78.1%
EBITDA %	30.8%	30.2%	15.3%	0.6p.p.	15.5p.p.
EBIT[3]	2,575	2,013	271	28.0%	849.1%
ROE[4] (annualized)	9.6%	9.0%	2.0%	0.6p.p.	7.6p.p.
ROA[5] (annualized)	4.61%	4.2%	1.1%	0.4p.p.	3.5p.p.
Capex[6]	5,826	7,018	10,484	-	-
Depreciation	1,880	2,357	2,119	-	-

Note: 1. EPS = Net Profit Attributable To The Shareholders of The Company / Weighted-average Number of Ordinary Shares Outstanding During The Period
2. EBITDA = Net Profit + Tax + Interests + Depreciation + Amortization
3. EBIT = Net Profit + Tax + interests
4. ROE = Net Profit / Average Shareholders Equity
5. ROA = (Net Profit + Interest(1- Effective Tax Rate)) / Average Asset*
6. Capex = Ending Acquisition of property, plant and equipment, and prepayments of equipment - Beginning Acquisition of property, plant and equipment, and prepayments of equipment

Financial Highlight : 2025 vs. 2024

(NT$Mn, except EPS)	2025	2024	YoY
Revenue	60,598	62,626	-3.2%
Gross Profit %	24.1%	31.6%	-7.5p.p.
Operating Income	8,636	14,118	-38.8%
Operating Income %	14.3%	22.5%	-8.2p.p.
Net Profit	7,312	9,839	-25.7%
Net Profit %	12.1%	15.7%	-3.6p.p.
EPS[1]	NT$15.29	NT$21.06	-NT$5.77
EBITDA[2]	17,340	18,010	-3.7%
EBITDA %	28.6%	28.8%	-0.2p.p.
EBIT[3]	8,392	9,832	-14.6%
ROE[4] (annualized)	7.9%	12.5%	-4.6p.p.
ROA[5] (annualized)	3.69%	5.1%	-1.4p.p.
Capex[6]	31,938	48,319	-
Depreciation	8,927	8,048	-

Note: 1. EPS = Net Profit Attributable To The Shareholders of The Company / Weighted-average Number of Ordinary Shares Outstanding During The Period
2. EBITDA = Net Profit + Tax + Interests + Depreciation + Amortization
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Income Statement

(NT$ Mn)	2023	2024	2025	2025 (simulated)[1]
Revenue	**70,651**	**62,626**	**60,598**	**58,114**
Growth (%)[2]	*0.5%*	*-11.4%*	*-3.2%*	-
Gross Profit	**26,441**	**19,804**	**14,624**	**18,227**
Gross Profit Margin (%)	*37.4%*	*31.6%*	*24.1%*	*31.4%*
EBITDA	**30,630**	**18,010**	**17,340**	**21,678**
EBITDA Margin (%)	*43.4%*	*28.8%*	*28.6%*	*37.3%*
Operating Income	**20,059**	**14,118**	**8,636[3]**	**12,704**
Operating Profit Margin (%)	*28.4%*	*22.5%*	*14.3%*	*21.9%*
Profit before Tax	**26,496**	**12,429**	**9,516**	**13,852**
Profit before Tax Margin (%)	*37.5%*	*19.8%*	*15.7%*	*23.8%*
Net Profit	**19,770**	**9,839**	**7,312[4]**	**10,848**
Net Profit Margin (%)	*28.0%*	*15.7%*	*12.1%*	*18.7%*
EPS (NT$)	**45.41**	**21.06**	**15.29**	**22.69**

Note: 1. Simulated figures exclude impacts from major expansions in the U.S., Italy, and Japan, as well as mark-to-market changes on Siltronic shares
2. Growth figures represent year-over-year (YoY) changes
3. 2025 Operating Income declined YoY, mainly due to trial production costs incurred at certain subsidiaries.
4. 2025 Net Profit declined YoY, mainly due to foreign exchange losses and mark-to-market fluctuations on Siltronic shares.

Balance Sheet

(NT$ Mn)	2023	2024	2025
Assets			
Cash and cash equivalents	26,165	38,929	19,484
Account receivable	10,116	10,265	10,113
Inventories	9,359	11,238	10,399
Property, plant and equipment	72,251	119,074	107,241[3]
Other assets	71,097	45,074	71,105
Total assets	**188,988**	**224,581**	**218,343**
Liabilities			
Short-term loan[1]	40,000	28,797	31,010[4]
Account payable	5,027	5,371	4,161
Long term loan[2]	14,542	37,678	43,244[4]
Other liabilities	62,966	61,706	46,632
Total liabilities	**122,534**	**133,553**	**125,048**
Shareholder equity	**66,454**	**91,028**	**93,295**

Cash-related other assets include:

(NT$ Mn)	**2025**
Deposits in banks held for three months or more	5,376
Restricted Cash	17,145
Note	6,255

Note: 1. The balance of short-term loans comprises short-term borrowings, commercial paper payable, and the current portions of long-term borrowings, corporate bonds payable, and convertible bonds payable
2. The balance of long-term loans includes long-term borrowings, corporate bonds payable, and exchangeable bonds payable
3. 2025 Property, plant and equipment declined YoY mainly reflecting accounting adjustments related to government subsidies and the U.S. AMIC (Advanced Manufacturing Investment Credit) tax incentives
4. 2025 Short-term loan and Long-term loan both increased, mainly due to the U.S. capacity expansion

04

ESG

Carbon Reduction Governance: SBTi Commitment & Group Net-Zero Strategy

- GlobalWafers follows the Science Based Targets initiative (SBTi) and formally committed in August 2025 to setting science-based emission reduction targets across its entire value chain. The Company aims to achieve net-zero greenhouse gas emissions by 2050, in response to customer expectations, alignment with industry leaders, and convergence with international climate standards.
- GlobalWafers will adopt the SBTi absolute contraction approach to define concrete decarbonization pathways, while concurrently enhancing its renewable energy roadmap to pursue a more ambitious energy transition aligned with global climate goals.

GlobalWafers' Decarbonization Strategy Framework

Energy Efficiency & Process Optimization

Lowering energy intensity through process, equipment, and utility optimization.

Renewable Energy Adoption

Scaling solar, PPAs, and RECs to achieve 100% renewable power by 2040.

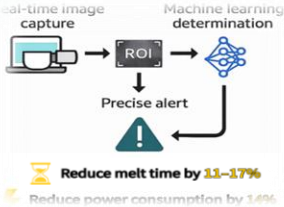
Value Chain Engagement

Driving supplier and customer collaboration to reduce Scope 3 emissions.

Green Manufacturing: Leveraging Innovation to Drive Smart Manufacturing and Sustainability Transformation

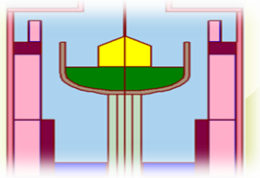
Equipment Upgrade

The Taisil Branch upgraded nearly 30-year-old equipment with high-efficiency variable-frequency systems, achieving over 4.7 million kWh in annual electricity savings and 2,826 metric tons of CO_2 reduction through upgrades to compressed air, chilled water, and crystal growth power systems.



AI-Enabled Process Optimization

AI-based image recognition optimizes material replenishment timing in the crystal growth process, reducing melting time and energy use, with approximately 14% electricity savings per furnace while improving productivity and carbon reduction.



Adoption of Energy-Efficient Materials

New low-thermal-conductivity materials replaced conventional carbon fiber in thermal field modules, delivering superior insulation, 5–10% additional energy savings, shorter production time, and over 50% reduction in material costs, with customization for different crystal furnace types.

Diversified Strategies to Enhance Energy Resilience

The Italian plant leveraged the “Energy Release” program, PPAs, and on-site solar to reach 34% renewable electricity in 2024, while strengthening CHP systems and adopting biomethane and recovered hydrogen to cut CO_2 emissions and advance its 2031 net-zero target.

People-Centric Workplace: Building a Safe and Supportive Work Environment

Employee Care & Maternity Support

- MKC (Korea) received the "Health-Friendly Company" certification from the Ministry of Health and Welfare.
- Comprehensive maternity support was provided, including prenatal assessments, personalized guidance, maternity parking, and lactation rooms.
- The Taisil Branch conducted integrated breast, ovarian, and cervical cancer screenings with individual health consultations.
- MEMC (U.S.) and KL (Malaysia) launched a school supplies sponsorship program for employees' children, engaging families and introducing children to their parents' industry.

Diversity, Equity & Inclusion Workplace

- Established a Human Rights Policy and DEI Workplace Statement to foster an inclusive culture.
- Received the Hsinchu Science Park Workplace Equality Excellence Award for three consecutive years.
- 178 managers and management trainees completed workplace violence prevention training to strengthen managerial awareness and communication.

Responsible Labor & Workplace Governance

- All employees completed annual RBA training covering labor rights, OHS, environmental protection, and ethics.
- KL (Malaysia) hosted RBA Awareness Week to embed RBA principles into daily work culture.

Social Engagement: Leveraging Core Capabilities to Support Science Education and Community Initiatives

Talent Development & Education Advancement

- Shared semiconductor materials and sustainability insights at the 40th Anniversary Lecture Series of National Central University College of Management.
- Sponsored the 2025 National Smart Manufacturing Big Data Analytics Competition, supporting smart manufacturing education with real process data.
- Sponsored the Pioneer Seedling Program – Public Science Camp for two consecutive years, advancing STEM and renewable energy education in underserved communities.
- S.p.A. partnered with local youth centers on the “Let Me Introduce Myself” program to build youth career readiness.
- GWA promoted STEM education to strengthen the local semiconductor talent pipeline.
- Global sites established long-term partnerships with universities and colleges to deepen industry–academia collaboration.

Social Engagement: Leveraging Core Capabilities to Support Science Education and Community Initiatives

Child & Youth Care and Inclusion

- Supported public-benefit screenings of “Taiwan Superheroes” at 12 community schools in Yilan, Hsinchu, and Miaoli, expanding learning opportunities for underserved children.
- Organized annual charitable fundraising campaigns, mobilizing employees to support social welfare organizations and provide emergency relief and recovery assistance.
- MKC supported employees with disabilities in the Chungcheongnam-do Para Games, promoting social inclusion through employment and empowerment.

Community Engagement & Sustainable Environmental Action

- Adopted the coastline near the Zhunan plant at Longfeng Fishing Harbor, hosting the “Earth-Friendly Beach Cleanup” for six consecutive years with employee and community participation.
- MKC joined South Korea’s “One Company, One Stream” initiative with the Cheonan City Government to protect waterways and remove invasive species.

GlobalWafers' ESG Awards and External Recognition

CDP 2025

Water Security "A"
Climate Change "B"
Supplier Engagement "A"

Taiwan Ratings

"twaa-" Long-term
"twa-1+" Short-term
Outlook "Stable"

Corporate Governance Evaluation

The Top 5% Among Tpex-listed Companies for 7 Consecutive Years

Hsinchu Science Park R&D Accaccomplishment Award

TIPS AA Certification for 6 Consecutive Years

FTSE4Good Index Series

FTSE4Good Index Series Constituent for 4 Consecutive Years

National Enterprise Environmental Protection Award

Award for
5 Consecutive Years

Taiwan Corporate Sustainability Awards (TCSA)

Sustainability Report – Platinum Award
Top 10 Sustainability Performance

CommonWealth Magazine's Excellence in Corporate Social Responsibility Awards

Ranking 15th place

2025 Taiwan Continuous Improvement Award

Winning Gold and Bronze Tower Awards

Hsinchu Science Park Excellence Award for Promoting Workplace Equality

Award for
3 Consecutive Years

05

Q&A